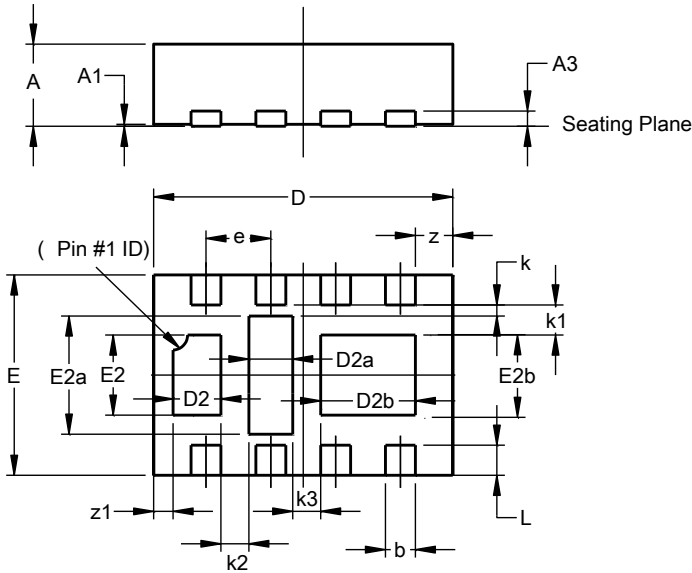


Package Outline Dimensions

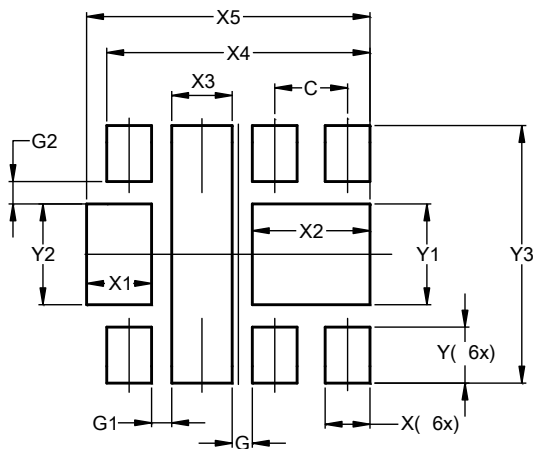
V-DFN3020-8 (Type P)



V-DFN3020-8 (Type P)			
Dim	Min	Max	Typ
A	0.77	0.83	0.80
A1	0.00	0.05	0.02
A3	-	-	0.152
b	0.25	0.35	0.30
D	2.95	3.05	3.00
D2	0.38	0.58	0.48
D2a	0.34	0.54	0.44
D2b	0.85	1.05	0.95
E	1.95	2.05	2.00
E2	0.70	0.90	0.80
E2a	1.08	1.28	1.18
E2b	0.70	0.90	0.80
e	-	-	0.65
k	-	-	0.11
k1	-	-	0.30
k2	-	-	0.28
k3	-	-	0.28
L	0.25	0.35	0.30
z	-	-	0.375
z1	-	-	0.195
All Dimensions in mm			

Suggested Pad Layout

V-DFN3020-8 (Type P)



Dimensions	Value (in mm)
C	0.650
G	0.180
G1	0.180
G2	0.200
X	0.400
X1	0.580
X2	1.050
X3	0.540
X4	2.350
X5	2.530
Y	0.500
Y1	0.900
Y2	0.900
Y3	2.300

ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.